A2F200M3F-FGG256 Information

For Reference Only

Part Number	A2F200M3F-FGG256
Manufacturer	Microsemi Corporation
Category	Integrated Circuits (ICs)
	Embedded - System On Chip (SoC)
Description	IC FPGA 256K FLASH 256FBGA
Package	256-LBGA

For the pricing/inventory/lead time, please contact us
Website: https://www.heisener.com
E-mail: salesdept@heisener.com

Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.

A2F200M3F-FGG256 Specifications

Manufacturer Part Number	A2F200M3F-FGG256
Manufacturer	Microsemi Corporation
Category	Integrated Circuits (ICs)
	Embedded - System On Chip (SoC)
Package	256-LBGA
Series	SmartFusion?
Architecture	MCU, FPGA
Core Processor	ARM? Cortex?-M3
Flash Size	256KB
RAM Size	64KB
Peripherals	DMA, POR, WDT
Connectivity	EBI/EMI, Ethernet, I2C, SPI, UART/USART
Speed	80MHz
Primary Attributes	ProASIC?3 FPGA, 200K Gates, 4608 D-Flip-Flops
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	256-LBGA
Supplier Device Package	256-FBGA (17x17)
	Report errors?

A2F200M3F-FGG256 Guarantees

Quality Guarantees
We provide 90 days warranty. *
If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.

Service Guarantees
We guarantee 100% customer satisfaction.
Our experienced sales team and tech support team back our services to satisfy all our customers.

A2F200M3F-FGG256 Payment Methods

A2F200M3F-FGG256 Shipping Methods

If you have any question about A2F200M3F-FGG256, please do not hesitate to contact us!
Website: https://www.heisener.com
E-mail: salesdept@heisener.com